BAV19WSFL THRU BAV21WSFL SOD-323FL

FEATURES

For surface mounted applications
Glass Passivated Chip Junction
Fast reverse recovery time
Ideal for automated placement
Lead





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Fig.1 Power Derating Curve

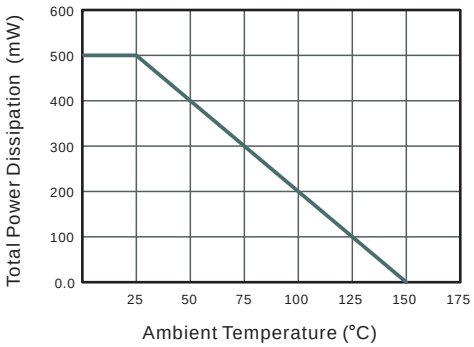
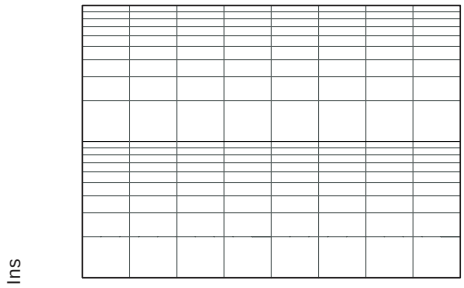


Fig.3 Typical Instaneous Forward Characteristics



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